

MOS FIELD EFFECT TRANSISTORS 2SK2369/2SK2370

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2369/2SK2370 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

• Low On-Resistance

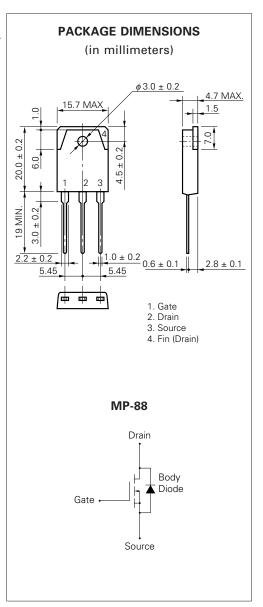
www.DataSheet4U.co2SK2369: RDS(on) = 0.35 Ω (Vgs = 10 V, ID = 10 A) 2SK2370: RDS(on) = 0.4 Ω (Vgs = 10 V, ID = 10 A)

- Low Ciss Ciss = 2400 pF TYP.
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

VDSS	450/500	V
Vgss	±30	V
ID(DC)	±20	Α
I _{D(pulse)}	±80	Α
P _{T1}	140	W
P _{T2}	3.0	W
Tch	150	°C
T _{stg} -	55 to +150	°C
las	20	Α
Eas	285	mJ
	VGSS ID(DC) ID(pulse) PT1 PT2 Tch Tstg - IAS	$\begin{array}{lllll} V_{GSS} & \pm 30 \\ I_{D(DC)} & \pm 20 \\ I_{D(pulse)} & \pm 80 \\ P_{T1} & 140 \\ P_{T2} & 3.0 \\ T_{ch} & 150 \\ T_{stg} & -55 \text{ to } +150 \\ I_{AS} & 20 \\ \end{array}$

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting Tch = 25 °C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0



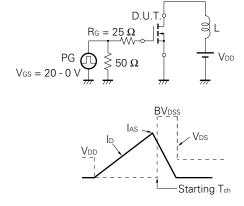


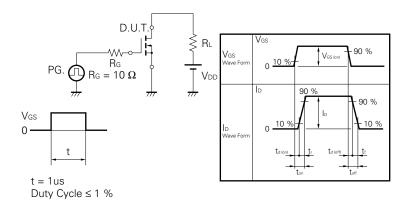
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-State Resistance	RDS(on)		0.30	0.35	Ω	V _{GS} = 10 V	2SK2369
			0.32	0.40		ID = 10 V	2SK2370
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA	
Forward Transfer Admittance	l y _{fs} l	7.5			S	V _{DS} = 10 V, I _D = 10 A	
Drain Leakage Current	IDSS			100	μΑ	V _{DS} = V _{DSS} , V _{GS} = 0	
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V, } V_{DS} = 0$	
Input Capacitance	Ciss		2400		pF	V _{DS} = 10 V	
Output Capacitance	Coss		500		pF	V _G S = 0	
Reverse Transfer Capacitance	Crss		45		pF	f = 1 MHz	
Turn-On Delay Time	td(on)		35		ns	ID = 10 A	
Rise Time	tr		60		ns	Vgs = 10 V	
Turn-Off Delay Time	td(off)		105		ns	V _{DD} = 150 V	
TaSheet4U.com Fall Time	tf		65		ns	$R_G = 10 \Omega R_L$	= 15 Ω
Total Gate Charge	Qg		65		nC	ID = 20 A	
Gate to Source Charge	Qgs		15		nC	V _{DD} = 400 V	
Gate to Drain Charge	Q _{GD}		30		nC	Vgs = 10 V	
Body Diode Forward Voltage	V _{F(S-D)}		1.0		V	IF = 20 A, VGS	= 0
Reverse Recovery Time	trr		500		ns	IF = 20 A, VGS	= 0
Reverse Recovery Charge	Qrr		3.5		μC	di/dt = 50 A/μs	3

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time



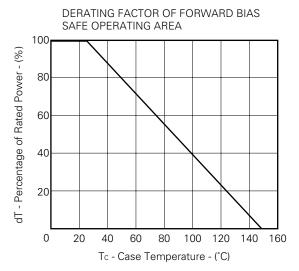


Test Circuit 3 Gate Charge

The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

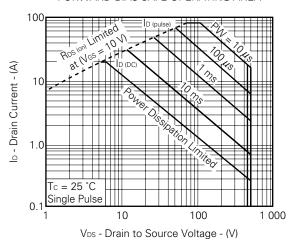
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TYPICAL CHARACTERISTICS (TA = 25 °C)

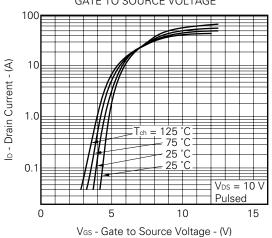


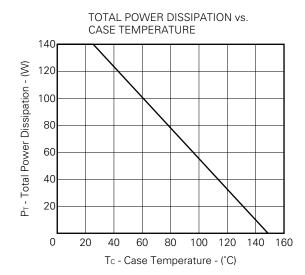
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FORWARD BIAS SAFE OPERATING AREA



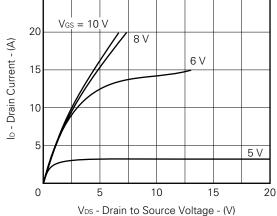
DRAIN CURRENT vs.
GATE TO SOURCE VOLTAGE

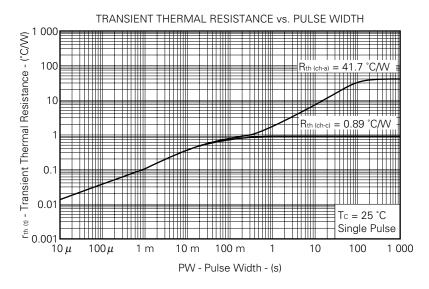




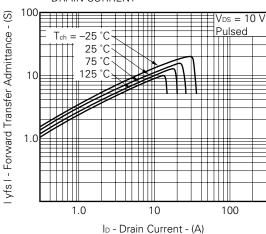
DRAIN CURRENT vs.
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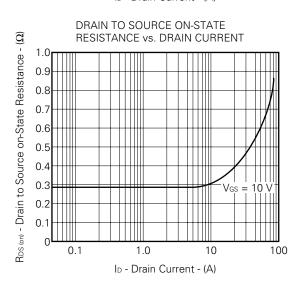
25
VGS = 10 V



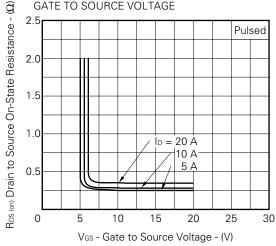


www.Data FORWARD TRANSFER ADMITTANCE vs.

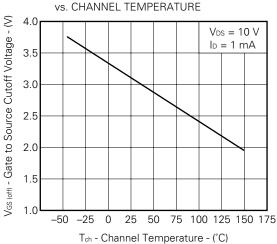




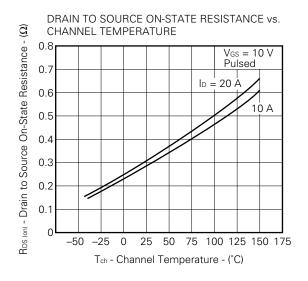
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

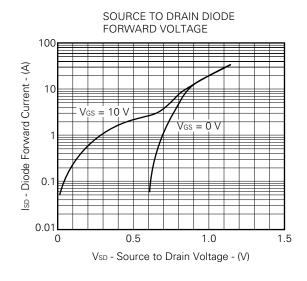


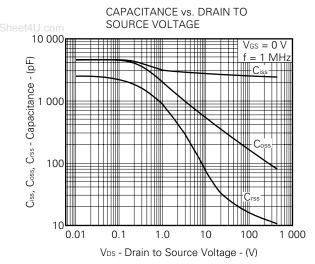
GATE TO SOURCE CUT OFF VOLTAGE VS. CHANNEL TEMPERATURE

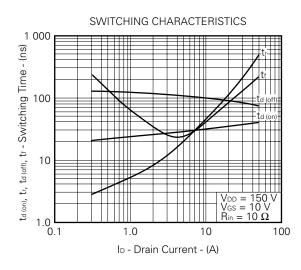


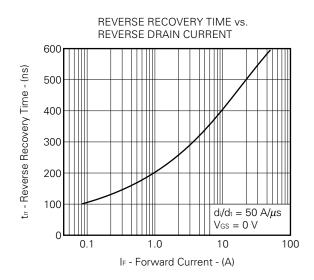
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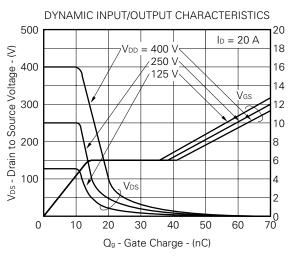


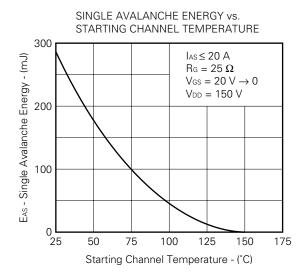


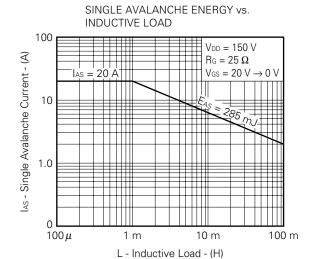












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REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the www.DataSheetrated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.

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